**ON Semiconductor** 

Is Now

# Onsemí

To learn more about onsemi<sup>™</sup>, please visit our website at <u>www.onsemi.com</u>

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product factures, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and asfety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or by customer's technical experts. onsemi products and actal performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application, Buyer shall indemnify and hold onsemi and its officers, employees, subsidiari





## on semiconductor® NDS8425

# Single N-Channel, 2.5V Specified PowerTrench<sup>®</sup> MOSFET

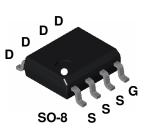
#### **General Description**

This N-Channel 2.5V specified MOSFET is produced using ON Semiconductor's advanced Power Trench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint package.

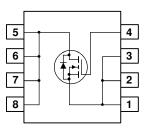
#### Applications

- DC/DC converter
- Load switch



#### Features

- 7.4 A, 20 V.  $\begin{array}{l} R_{DS(ON)} = 0.022 \; \Omega \; @ \; V_{GS} = 4.5 \; V \\ R_{DS(ON)} = 0.028 \; \Omega \; @ \; V_{GS} = 2.7 \; V \end{array}$
- Fast switching speed
- Low gate charge (11nC typical)
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High power and current handling capability in a widely used surface mount package



### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		20	V
V <sub>GSS</sub>	Gate-Source Voltage		±8	V
ID	Drain Current – Continuous	(Note 1a)	±7.4	A
	- Pulsed		±20	
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

#### Package Marking and Ordering Information

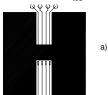
Device Marking	Device	Reel Size	Tape width	Quantity
NDS8425	NDS8425	13"	12mm	2500 units

©2001 Semiconductor Components Industries, LLC. September-2017, Rev. 4

Publication Order Number: NDS8425/D

**Electrical Characteristics**  $T_{A} = 25^{\circ}C$  unless otherwise noted Symbol Parameter Min Max Units **Test Conditions** Тур **Off Characteristics** Drain-Source Breakdown Voltage  $V_{GS} = 0 V, I_D = 250 \mu A$ 20 V Breakdown Voltage Temperature  $I_D = 250 \ \mu A$ , Referenced to  $25^{\circ}C$ 14 mV/°C Coefficient  $V_{DS} = 16 V$ ,  $V_{GS} = 0 V$ 1 Zero Gate Voltage Drain Current μA  $V_{DS} = 16 V, V_{GS} = 0 V, T_{J} = 55^{\circ}C$ 10 Gate-Body Leakage, Forward  $V_{GS} = 8 V$ ,  $V_{\text{DS}} = 0 V$ 100 nA Gate-Body Leakage, Reverse  $V_{GS} = -8 V$  $V_{DS} = 0 V$ -100 nA On Characteristics (Note 2) Gate Threshold Voltage  $V_{\text{DS}} = V_{\text{GS}}, \, I_{\text{D}} = 250 \; \mu \text{A}$ V 0.4 0.89 1.5 Gate Threshold Voltage  $I_D = 250 \ \mu A$ , Referenced to  $25^{\circ}C$ -3 mV/°C Temperature Coefficient  $I_D = 7.4 \text{ A}$  $V_{GS} = 4.5 V,$ 15 Static Drain-Source 22 mΩ **On-Resistance**  $V_{GS} = 4.5 \text{ V}, I_D = 7.4 \text{ A}, T_J = 125^{\circ}\text{C}$ 21 31 V<sub>GS</sub>=2.7 V, I<sub>D</sub> =7.2A 19 28  $V_{GS} = 4.5 V$ , **On–State Drain Current**  $V_{DS} = 5 V$ 20 А Forward Transconductance  $V_{DS} = 5 V$ ,  $I_{D} = 7.4 \text{ A}$ 31 S **Dynamic Characteristics** Input Capacitance 1098 pF  $V_{DS} = 15 V$ ,  $V_{GS} = 0 V$ , **Output Capacitance** f = 1.0 MHz 240 pF **Reverse Transfer Capacitance** 115 pF Switching Characteristics (Note 2) Turn-On Delay Time  $I_D = 1 A$ , 9 18  $V_{DS} = 15 V$ , ns  $R_{\text{GEN}}=6~\Omega$  $V_{GS} = 4.5 V$ , Turn-On Rise Time 13 24 ns Turn-Off Delay Time 26 42 ns Turn–Off Fall Time 11 20 ns **Total Gate Charge**  $V_{DS} = 10 V$ ,  $I_{D} = 7.4 \text{ A},$ 11 18 nC  $V_{GS} = 4.5 V$ Gate-Source Charge 2.5 nC Gate-Drain Charge 3.1 nC Drain–Source Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current 1.9 А Drain-Source Diode Forward  $V_{GS} = 0 V$ ,  $I_{S} = 1.9 A$ 0.72 1.3 v (Note 2) Voltage 1. R<sub>0,JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of

the drain pins.  $R_{_{\theta JC}}$  is guaranteed by design while  $R_{_{\theta CA}}$  is determined by the user's board design.



Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

BV<sub>DSS</sub>

 $\Delta BV_{DSS}$ 

 $\Delta T_{\rm J}$ 

IDSS

IGSSF

IGSSR

V<sub>GS(th)</sub>

 $\Delta V_{GS(th)}$ 

 $\Delta T_{\rm J}$ 

R<sub>DS(on)</sub>

I<sub>D(on)</sub>

**g**fs

 $C_{iss}$ 

Coss

 $C_{rss}$ 

t<sub>d(on)</sub>

t<sub>d(off)</sub>

tr

tf Qg

Qas

 $Q_{gd}$ 

 $I_{S}$ 

 $V_{\text{SD}}$ 

Notes:

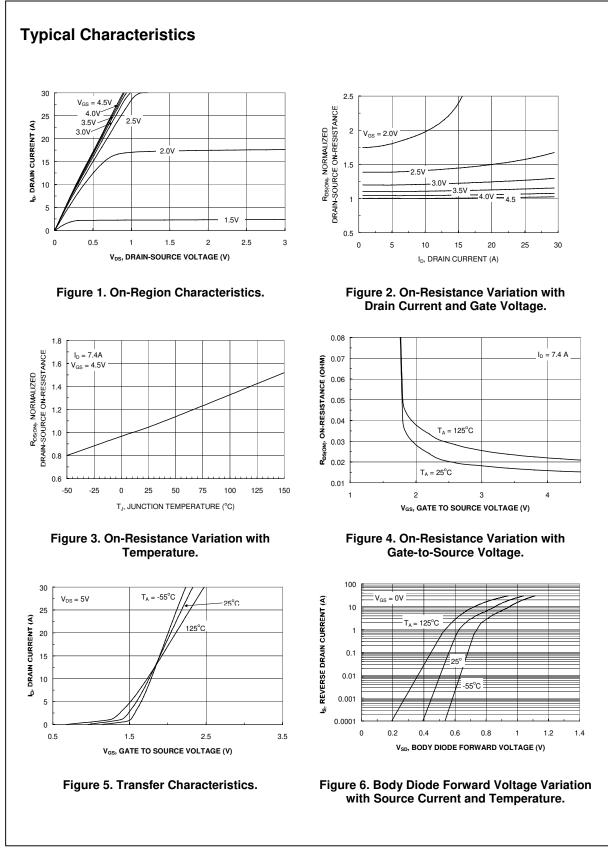
50°/W when
mounted on a 1 in <sup>2</sup>
pad of 2 oz copper

αφφρ b) 105°/W when mounted on a .04 in<sup>2</sup> pad of 2 oz copper

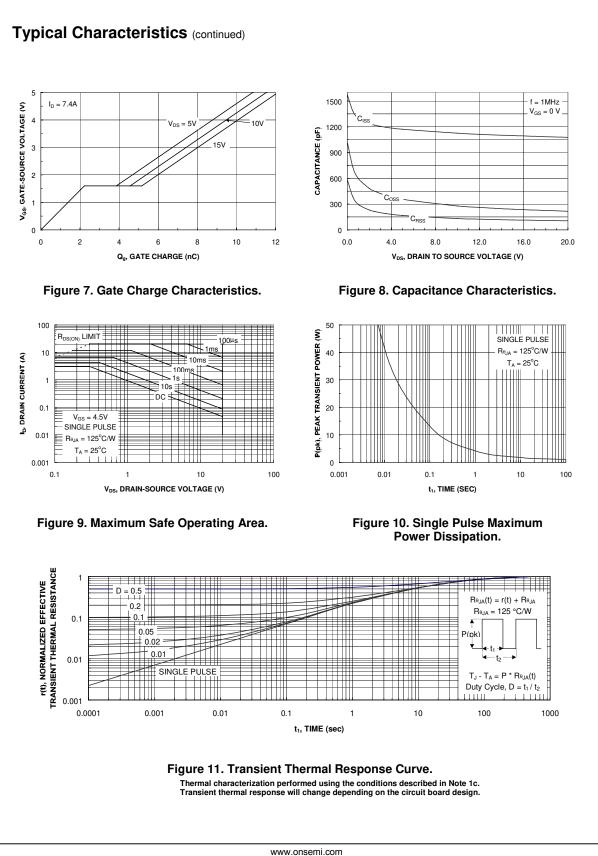
c) 125°/W when mounted on a minimum pad.

**NDS8425** 

www.onsemi.com



# NDS8425



NDS8425

w.onsemi.co 4

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such uninten

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative